# 2SC4212

## Silicon NPN triple diffusion planar type

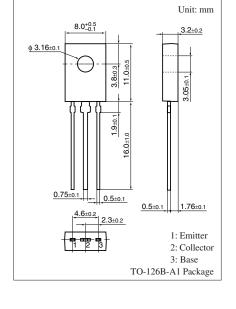
#### For color TV horizontal deflection driver

#### ■ Features

- $\bullet$  High collector-emitter voltage (Base open)  $V_{\text{CEO}}$
- TO-126B package which requires no insulation plate for installation to the heat sink

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	350	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	300	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	7.5	V	
Collector current	$I_C$	200	mA	
Peak collector current	$I_{CP}$	400	mA	
Collector power	$P_{C}$	1.2	W	
dissipation		5.0 *		
Junction temperature	$T_{j}$	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



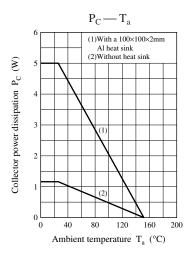
Note) \*: With a  $100 \times 100 \times 2$  mm Al heat sink

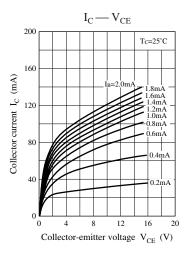
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

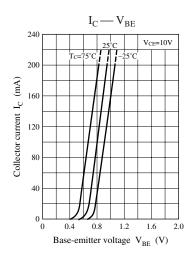
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 100 \mu\text{A},  I_E = 0$	350			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 5 \text{ mA}, I_B = 0$	300			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 100 \ \mu A, I_C = 0$	7.5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 200 \text{ V}, I_{E} = 0$			2	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 5 \text{ V}, I_{C} = 0$			2	μΑ
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 10 \text{ mA}$	40		250	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$			1	V
Transition frequency	$f_T$	$V_{CB} = 30 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$	50	80		MHz
Collector output capacitance	Cob	$V_{CB} = 50 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$			4.5	pF
(Common base, input open circuited)						

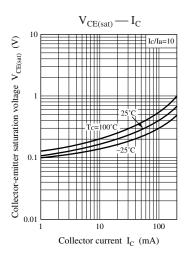
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

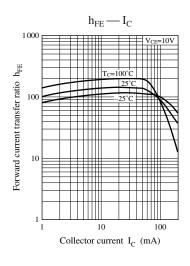
## **Panasonic**

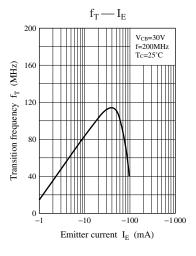


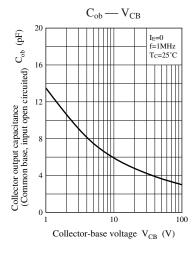


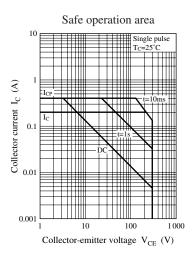












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